Notice for TAIYO YUDEN products

Please read this notice before using the TAIYO YUDEN products.

REMINDERS

Product Information in this Catalog

Product information in this catalog is as of January 2021. All of the contents specified herein and production status of the products listed in this catalog are subject to change without notice due to technical improvement of our products, etc. Therefore, please check for the latest information carefully before practical application or use of our products.

Please note that TAIYO YUDEN shall not be in any way responsible for any damages and defects in products or equipment incorporating our products, which are caused under the conditions other than those specified in this catalog or individual product specification sheets.

Approval of Product Specifications

Please contact TAIYO YUDEN for further details of product specifications as the individual product specification sheets are available. When using our products, please be sure to approve our product specifications or make a written agreement on the product specification with TAIYO YUDEN in advance.

Pre-Evaluation in the Actual Equipment and Conditions

Please conduct validation and verification of our products in actual conditions of mounting and operating environment before using our products.

Limited Application

1. Equipment Intended for Use

The products listed in this catalog are intended for generalpurpose and standard use in general electronic equipment (e.g., AV equipment, OA equipment, home electric appliances, office equipment, information and communication equipment including, without limitation, mobile phone, and PC) and other equipment specified in this catalog or the individual product specification sheets.

TAIYO YUDEN has the line-up of the products intended for use in automotive electronic equipment, telecommunications infrastructure and industrial equipment, or medical devices classified as GHTF Classes A to C (Japan Classes I to III). Therefore, when using our products for these equipment, please check available applications specified in this catalog or the individual product specification sheets and use the corresponding products.

2. Equipment Requiring Inquiry

Please be sure to contact TAIYO YUDEN for further information before using the products listed in this catalog for the following equipment (excluding intended equipment as specified in this catalog or the individual product specification sheets) which may cause loss of human life, bodily injury, serious property damage and/or serious public impact due to a failure or defect of the products and/or malfunction attributed thereto.

- (1) Transportation equipment (automotive powertrain control system, train control system, and ship control system, etc.)
- (2) Traffic signal equipment
- (3) Disaster prevention equipment, crime prevention equipment
- (4) Medical devices classified as GHTF Class C (Japan Class III)
- (5) Highly public information network equipment, dataprocessing equipment (telephone exchange, and base station, etc.)
- (6) Any other equipment requiring high levels of quality and/or reliability equal to the equipment listed above

3. Equipment Prohibited for Use

Please do not incorporate our products into the following equipment requiring extremely high levels of safety and/or reliability.

- (1) Aerospace equipment (artificial satellite, rocket, etc.)
- (2) Aviation equipment *1
- (3) Medical devices classified as GHTF Class D (Japan Class IV), implantable medical devices *²

- (4) Power generation control equipment (nuclear power, hydroelectric power, thermal power plant control system, etc.)
- (5) Undersea equipment (submarine repeating equipment, underwater work equipment, etc.)
- (6) Military equipment
- Any other equipment requiring extremely high levels of safety and/or reliability equal to the equipment listed above

*Notes:

- There is a possibility that our products can be used only for aviation equipment that does not directly affect the safe operation of aircraft (e.g., in-flight entertainment, cabin light, electric seat, cooking equipment) if such use meets requirements specified separately by TAIYO YUDEN. Please be sure to contact TAIYO YUDEN for further information before using our products for such aviation equipment.
- Implantable medical devices contain not only internal unit which is implanted in a body, but also external unit which is connected to the internal unit.

4. Limitation of Liability

Please note that unless you obtain prior written consent of TAIYO YUDEN, TAIYO YUDEN shall not be in any way responsible for any damages incurred by you or third parties arising from use of the products listed in this catalog for any equipment that is not intended for use by TAIYO YUDEN, or any equipment requiring inquiry to TAIYO YUDEN or prohibited for use by TAIYO YUDEN as described above.

Safety Design

When using our products for high safety and/or reliability-required equipment or circuits, please fully perform safety and/or reliability evaluation. In addition, please install (i) systems equipped with a protection circuit and a protection device and/or (ii) systems equipped with a redundant circuit or other system to prevent an unsafe status in the event of a single fault for a failsafe design to ensure safety.

Intellectual Property Rights

Information contained in this catalog is intended to convey examples of typical performances and/or applications of our products and is not intended to make any warranty with respect to the intellectual property rights or any other related rights of TAIYO YUDEN or any third parties nor grant any license under such rights.

Limited Warranty

Please note that the scope of warranty for our products is limited to the delivered our products themselves and TAIYO YUDEN shall not be in any way responsible for any damages resulting from a failure or defect in our products. Notwithstanding the foregoing, if there is a written agreement (e.g., supply and purchase agreement, quality assurance agreement) signed by TAIYO YUDEN and your company, TAIYO YUDEN will warrant our products in accordance with such agreement.

TAIYO YUDEN's Official Sales Channel

The contents of this catalog are applicable to our products which are purchased from our sales offices or authorized distributors (hereinafter "TAIYO YUDEN's official sales channel"). Please note that the contents of this catalog are not applicable to our products purchased from any seller other than TAIYO YUDEN's official sales channel.

Caution for Export

Some of our products listed in this catalog may require specific procedures for export according to "U.S. Export Administration Regulations", "Foreign Exchange and Foreign Trade Control Law" of Japan, and other applicable regulations. Should you have any questions on this matter, please contact our sales staff.

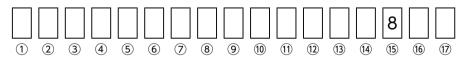
Industrial Application Guide

The products described as "For Telecommunications Infrastructure and Industrial Equipment" in this catalog are intended for use in the equipment shown in the below table as its typical example. Therefore, when using our products for these equipment, please check it carefully by referring to the part number or the individual product specification sheets and use the corresponding products. Should you have any questions on this matter, please contact us.

Category	Telecommunications Infrastructure and Industrial Equipment (Typical Example)
Telecommunications Infrastructure	 Base Station Optical Transceiver Router/Switch (Carrier-Grade) UPS (Uninterruptible Power Supply), etc.
Factory Automation	 PLC (Programmable Logic Controller) Servomotor/Servo Driver Industry Robot, etc.
Measurement	 Gas Meter Water Meter Flow Meter Pressure Gauge Meter Magnetometer Thermometer, etc.
Electric Power Apparatus	 Power Conditioner (Solar Power System) Smart Meter GFCI (Ground Fault Circuit Interrupter) Electric Vehicle Charging Station, etc.

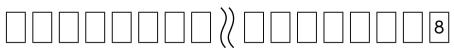
Part Numbering System

Multilayer Ceramic Capacitors:



If the 15th code from the left is "8", it indicates "For Telecommunications Infrastructure and Industrial Equipment" or "For Medical Devices".

Inductors:



If the 1st code from the right is "8" regardless of the total digit number, it indicates "For Telecommunications Infrastructure and Industrial Equipment" or "For Medical Devices".

Because there are some exceptions, for details please refer to each page of this catalog where the part numbering system of each product is described.

This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our product specification sheets. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our website (http://www.ty-top.com/).

Medical Application Guide

The products described as "For Medical Devices" in this catalog are intended for use in the medical devices classified as GHTF Classes A to C (Japan Classes I to III) except for all medical devices classified as GHTF Class D (Japan Class IV) and implantable medical devices (bone-anchored hearing aid, artificial retina system, and external unit which is connected to internal unit which is implanted in a body, etc.). Therefore, when using our products for these medical devices, please check it carefully by referring to the part number or the individual product specification sheets and use the corresponding products. Should you have any questions on this matter, please contact us.

Risk I	Level	Low					High
	Act of Japan s)	Class I General Medical Devices (GHTF Class A)	Me (G	Class II Controlled dical Devices HTF Class B) devices with	Class III Specially-contr Medical Dev (GHTF Class Medical devices v	rolled ices 5 C)	Class IV Specially-controlled Medical Devices (GHTF Class D)
	an big difference of the second secon	extremely low risk to the relative human body in case of human		low risk to the body in case of	relatively high risk to the human body in case of problems		Medical devices highly invasive to patients and with life-threatening risk in case of problems
Japan		[Ex.] [Ex.] · Electronic Thermometer · Di · Electronic Blood Pressure · Ra Gauge · In · Electronic Endoscope · Re · Hearing Aid · Gi · Electrocardiograph · AR · MRI Di · Ultrasonic Diagnostic System · Sk · Diagnostic Imaging Equipment · Election		problems [Ex.] • Dialysis Machine • Radiation Therapy Equipment • Infusion Pump • Respirator • Glucose Monitoring System • AED (Automated External Defibrillator) • Skin Laser Scanner • Electric Surgical Unit • Insulin Pump, etc.		[Ex.] Cardiac Pacemaker Video Flexible Angioscope Implantable Infusion Pump Cardiac Electrosurgical Unit Inspection Device with Cardiac Catheter Defibrillator, etc.	
	Classification	Class I General Controls		Cla General Co Special (ontrols and		Class III General Controls and Premarket Approval
U.S.A.	FDA Classif	Medical devices without the p of causing serious injury or l to the patient or user even i is a defect or malfunction in medical devices	harm f there	Medical devices w of causing injury o patient or user if th malfunction in suc	r harm to the nere is a defect or	of causir or death	devices with the possibility g serious injury, disability to the patient or user if a r malfunction occurs in such devices

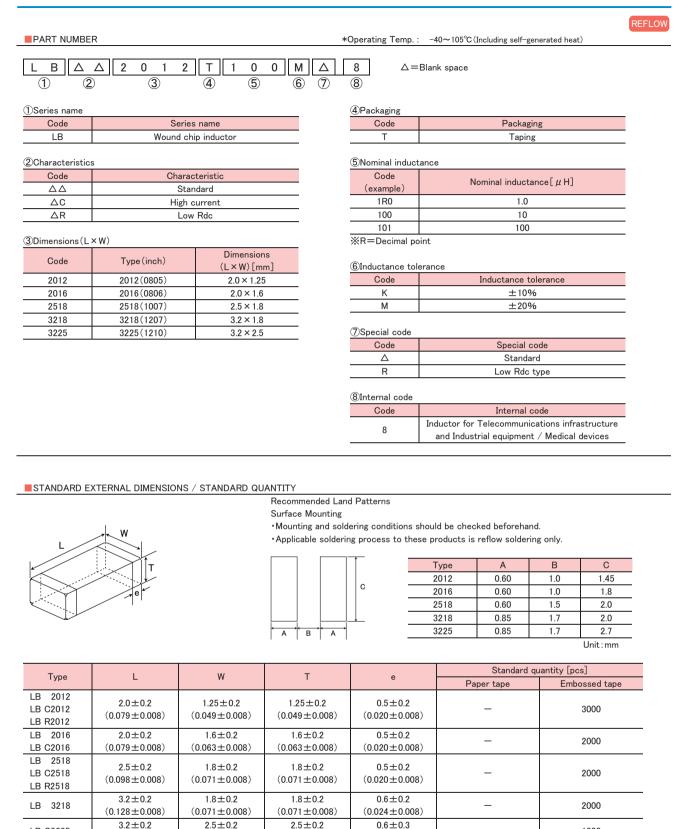
Coverage of
those Classes by
TAIYO YUDEN
Products

Product Series for Medical Devices

*Note: It is prohibited that our products are used in some medical devices such as implantable medical devices even if such medical devices are classified as GHTF Class C (Japan Class III).

N/A

WIRE-WOUND CHIP INDUCTORS (LB SERIES)



This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our product specification sheets. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our website (http://www.ty-top.com/).

 (0.024 ± 0.012)

1000

Unit:mm(inch)

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 (0.098 ± 0.008)

LB C3225

 (0.128 ± 0.008)

 (0.098 ± 0.008)

for High Quality Equipment

PART NUMBER

· All the Wire-wound Chip Inductors of the catalog lineup are RoHS compliant.

Notes)

• The exchange of individual specifications is necessary depending on your application and/or circuit condition. Please contact TAIYO YUDEN's official sales channel.

· The products are for Telecommunications infrastructure and Industrial equipment and for Medical devices.

Please consult with TAIYO YUDEN's official sales channel for the details of the product specifications, etc.,

and please review and approve the product specifications before ordering.

Please be sure to contact us for further information in advance when the products are used for automotive electronic equipment.

2012(0805)type							
Part number	Nominal inductance [µ H]	Inductance tolerance	Self-resonant frequency [MHz] (min.)	DC Resistance [Ω](±30%)	Rated current [mA](max.)	Measuring frequency [MHz]	Note
LB 2012T1R0M 8	1.0	±20%	100	0.15	405	7.96	
LB 2012T2R2M 8	2.2	±20%	80	0.23	260	7.96	
LB 2012T3R3M 8	3.3	±20%	55	0.30	235	7.96	
LB 2012T4R7M 8	4.7	±20%	45	0.40	190	7.96	
LB 2012T6R8M 8	6.8	±20%	38	0.47	135	7.96	
LB 2012T100[] 8	10	±10%, ±20%	32	0.70	120	2.52	
LB 2012T100[R8	10	±10%, ±20%	32	0.50	120	2.52	
LB 2012T150[] 8	15	±10%, ±20%	28	1.3	100	2.52	
LB 2012T220[] 8	22	±10%, ±20%	16	1.7	80	2.52	
LB 2012T470[] 8	47	±10%, ±20%	11	3.7	60	2.52	
LB 2012T680[] 8	68	±10%, ±20%	10	6.0	50	2.52	
LB 2012T101 8	100	±10%, ±20%	8	7.0	45	0.796	

Part number	Nominal inductance [µ H]	Inductance tolerance	Self-resonant frequency [MHz](min.)	DC Resistance $[\Omega](\pm 30\%)$	Rated current [mA](max.)	Measuring frequency [MHz]	Note
LB C2012T1R0M 8	1.0	±20%	100	0.19	620	7.96	
LB C2012T2R2M 8	2.2	±20%	70	0.33	430	7.96	
LB C2012T4R7M 8	4.7	±20%	45	0.50	295	7.96	
LB C2012T100[] 8	10	±10%, ±20%	40	1.2	200	2.52	
LB C2012T220[] 8	22	±10%, ±20%	16	3.7	130	2.52	
LB C2012T470[] 8	47	±10%, ±20%	11	5.8	90	2.52	

Part number	Nominal inductance [μΗ]	Inductance tolerance	Self-resonant frequency [MHz](min.)	DC Resistance [Ω](±30%)	Rated current [mA](max.)	Measuring frequency [MHz]	Note
LB R2012T1R0M 8	1.0	±20%	100	0.07	400	7.96	
LB R2012T2R2M 8	2.2	±20%	80	0.13	260	7.96	
LB R2012T4R7M 8	4.7	±20%	45	0.24	200	7.96	
LB R2012T100 8	10	±10%, ±20%	32	0.36	150	2.52	
LB R2012T220[] 8	22	±10%, ±20%	16	1.0	100	2.52	
LB R2012T470 8	47	±10%, ±20%	11	1.7	75	2.52	
LB R2012T101[] 8	100	±10%, ±20%	8	4.0	50	0.796	

2016(0806)type

Part number	Nominal inductance [Inductance tolerance	Self-resonant frequency [MHz](min.)	DC Resistance [Ω](±30%)	Rated current [mA](max.)	Measuring frequency [MHz]	Note
LB 2016T1R0M 8	1.0	±20%	100	0.09	490	7.96	
LB 2016T1R5M 8	1.5	±20%	80	0.11	380	7.96	
LB 2016T2R2M 8	2.2	±20%	70	0.13	375	7.96	
LB 2016T3R3M 8	3.3	±20%	55	0.20	285	7.96	
LB 2016T4R7M 8	4.7	±20%	45	0.25	225	7.96	
LB 2016T6R8M 8	6.8	±20%	38	0.35	200	7.96	
LB 2016T100[] 8	10	±10%, ±20%	32	0.50	155	2.52	
LB 2016T150[]8	15	±10%, ±20%	28	0.70	130	2.52	
LB 2016T220[] 8	22	±10%, ±20%	16	1.0	105	2.52	
LB 2016T330[] 8	33	±10%, ±20%	14	1.7	85	2.52	
LB 2016T470[] 8	47	±10%, ±20%	11	2.4	70	2.52	
LB 2016T680[] 8	68	±10%, ±20%	10	3.0	55	2.52	
LB 2016T101[] 8	100	±10%, ±20%	8	4.5	40	0.796	

Part number	Nominal inductance [μΗ]	Inductance tolerance	Self-resonant frequency [MHz](min.)	DC Resistance [Ω](±30%)	Rated current [mA](max.)	Measuring frequency [MHz]	Note
LB C2016T1R0M 8	1.0	±20%	100	0.10	690	7.96	
LB C2016T1R5M 8	1.5	±20%	80	0.15	600	7.96	
LB C2016T2R2M 8	2.2	±20%	70	0.20	520	7.96	
LB C2016T3R3M 8	3.3	±20%	55	0.27	410	7.96	
LB C2016T4R7M 8	4.7	±20%	45	0.37	355	7.96	
LB C2016T6R8M 8	6.8	±20%	38	0.59	290	7.96	
LB C2016T100 8	10	±10%, ±20%	32	0.82	245	2.52	
LB C2016T150[] 8	15	±10%, ±20%	28	1.2	200	2.52	
LB C2016T220[] 8	22	±10%, ±20%	16	1.8	165	2.52	
LB C2016T330[] 8	33	±10%, ±20%	14	2.8	135	2.52	
LB C2016T470 8	47	±10%, ±20%	11	4.3	110	2.52	
LB C2016T680[] 8	68	±10%, ±20%	10	7.0	95	2.52	
LB C2016T101[] 8	100	±10%, ±20%	8	8.0	75	0.796	

• [] Please specify the Inductance tolerance code(K or M)

LB, LBCseries

*) Rated Current: The maximum DC value having inductance decrease within 10 % and temperature increase within 20 degC by the application of DC bias.

LBRseries

X)Rated Current: The maximum DC value having inductance decrease within 20 % and temperature increase within 20 degC by the application of DC bias.

Part number	Nominal inductance [µ H]	Inductance tolerance	Self-resonant frequency [MHz] (min.)	DC Resistance $[\Omega](\pm 30\%)$	Rated current [mA] (max.)	Measuring frequency [MHz]	Note
LB 2518T1R0M 8	1.0	±20%	100	0.06	665	7.96	
LB 2518T1R5M 8	1.5	±20%	80	0.07	405	7.96	
LB 2518T2R2M 8	2.2	±20%	68	0.09	340	7.96	
LB 2518T3R3M 8	3.3	±20%	54	0.11	280	7.96	
LB 2518T4R7M 8	4.7	±20%	46	0.13	240	7.96	
LB 2518T4R7MR8	4.7	±20%	46	0.10	235	7.96	
LB 2518T6R8M 8	6.8	±20%	38	0.15	195	7.96	
LB 2518T100[]8	10	±10%, ±20%	30	0.25	165	2.52	
LB 2518T150[] 8	15	±10%, ±20%	23	0.32	145	2.52	
LB 2518T220[] 8	22	±10%, ±20%	19	0.50	115	2.52	
LB 2518T330[]8	33	±10%, ±20%	15	0.70	95	2.52	
LB 2518T470[]8	47	±10%, ±20%	12	0.95	85	2.52	
LB 2518T680[]8	68	±10%, ±20%	9.5	1.5	70	2.52	
LB 2518T101[]8	100	±10%, ±20%	9.0	2.1	60	0.796	
LB 2518T151[]8	150	±10%, ±20%	7.0	3.2	45	0.796	
LB 2518T221[] 8	220	±10%, ±20%	5.5	4.5	40	0.796	
LB 2518T331[]8	330	±10%, ±20%	4.5	7.0	30	0.796	
LB 2518T471[]8	470	±10%, ±20%	3.5	10	25	0.796	
LB 2518T681[]8	680	±10%, ±20%	3.0	17	20	0.796	
LB 2518T102 8	1000	±10%, ±20%	2.4	24	15	0.252	

Part number	Nominal inductance [Inductance tolerance	Self-resonant frequency [MHz] (min.)	DC Resistance $[\Omega](\pm 30\%)$	Rated current [mA] (max.)	Measuring frequency [MHz]	Note
LB C2518T1R0M 8	1.0	±20%	100	0.080	775	7.96	
LB C2518T1R0MR8	1.0	±20%	100	0.065	890	7.96	
LB C2518T1R5M 8	1.5	±20%	80	0.110	730	7.96	
LB C2518T2R2M 8	2.2	±20%	68	0.130	630	7.96	
LB C2518T3R3M 8	3.3	±20%	54	0.160	560	7.96	
LB C2518T4R7M 8	4.7	±20%	41	0.200	510	7.96	
LB C2518T6R8M 8	6.8	±20%	38	0.300	420	7.96	
LB C2518T100[] 8	10	±10%, ±20%	30	0.360	375	2.52	
LB C2518T150[] 8	15	±10%, ±20%	23	0.650	285	2.52	
LB C2518T220[] 8	22	±10%, ±20%	19	0.770	250	2.52	
LB C2518T330[] 8	33	±10%, ±20%	15	1.50	185	2.52	
LB C2518T470[] 8	47	±10%, ±20%	12	1.90	165	2.52	
LB C2518T680[] 8	68	±10%, ±20%	9.5	2.80	140	2.52	
LB C2518T101[] 8	100	±10%, ±20%	9.0	3.70	125	0.796	
LB C2518T151[] 8	150	±10%, ±20%	7.0	6.10	95	0.796	
LB C2518T221[] 8	220	±10%, ±20%	5.5	8.40	80	0.796	
LB C2518T331[] 8	330	±10%, ±20%	4.5	12.3	65	0.796	
LB C2518T471[] 8	470	±10%, ±20%	3.5	22.0	50	0.796	
LB C2518T681 8	680	±10%, ±20%	3.0	28.0	45	0.796	

Part number	Nominal inductance [Inductance tolerance	Self-resonant frequency [MHz] (min.)	DC Resistance $[\Omega](\pm 30\%)$	Rated current [mA](max.)	Measuring frequency [MHz]	Note
LB R2518T1R0M 8	1.0	±20%	100	0.045	960	7.96	
LB R2518T2R2M 8	2.2	±20%	68	0.07	480	7.96	
LB R2518T4R7M 8	4.7	±20%	45	0.10	345	7.96	
LB R2518T100 8	10	±10%, ±20%	30	0.19	235	2.52	
LB R2518T220 8	22	±10%, ±20%	19	0.44	175	2.52	
LB R2518T470[] 8	47	±10%, ±20%	11	0.84	120	2.52	
LB R2518T101[] 8	100	±10%, ±20%	9	1.89	80	0.796	

3218(1207)type

Part number	Nominal inductance [μH]	Inductance tolerance	Self-resonant frequency [MHz] (min.)	DC Resistance $[\Omega](\pm 30\%)$	Rated current [mA](max.)	Measuring frequency [MHz]	Note
LB 3218T1R0M 8	1.0	±20%	100	0.06	1,075	7.96	
LB 3218T1R5M 8	1.5	±20%	80	0.07	860	7.96	
LB 3218T2R2M 8	2.2	±20%	68	0.09	775	7.96	
LB 3218T3R3M 8	3.3	±20%	54	0.11	560	7.96	
LB 3218T4R7M 8	4.7	±20%	41	0.13	550	7.96	
LB 3218T6R8M 8	6.8	±20%	40	0.17	380	7.96	
LB 3218T100[]8	10	±10%, ±20%	30	0.25	340	2.52	
LB 3218T150[]8	15	±10%, ±20%	25	0.32	300	2.52	
LB 3218T220[]8	22	±10%, ±20%	19	0.49	255	2.52	
LB 3218T330[]8	33	±10%, ±20%	15	0.75	215	2.52	
LB 3218T470[]8	47	±10%, ±20%	12	0.92	205	2.52	
LB 3218T680[]8	68	±10%, ±20%	11	1.49	145	2.52	
LB 3218T101[]8	100	±10%, ±20%	8.0	2.4	140	0.796	
LB 3218T151[]8	150	±10%, ±20%	7.0	3.2	105	0.796	
LB 3218T221[]8	220	±10%, ±20%	5.0	5.4	80	0.796	
LB 3218T331[]8	330	±10%, ±20%	4.0	7.0	65	0.796	
LB 3218T471[]8	470	±10%, ±20%	3.5	14	54	0.796	
LB 3218T681[]8	680	±10%, ±20%	3.0	17	45	0.796	
LB 3218T102[]8	1000	±10%, ±20%	2.4	27	39	0.252	

Please specify the Inductance tolerance code(K or M)

•LB、LBCseries

*) Rated Current: The maximum DC value having inductance decrease within 10 % and temperature increase within 20 degC by the application of DC bias.

LBRseries

X)Rated Current: The maximum DC value having inductance decrease within 20 % and temperature increase within 20 degC by the application of DC bias.

for High Quality Equipment

PART NUMBER

Part number	Nominal inductance [μ H]	Inductance tolerance	Self-resonant frequency [MHz] (min.)	DC Resistance $[\Omega](\pm 30\%)$	Rated current [mA](max.)	Measuring frequency [MHz]	Note
B C3225T1R0MR8	1.0	±20%	250	0.055	1,100	0.1	
B C3225T1R5MR8	1.5	±20%	220	0.060	1,000	0.1	
B C3225T2R2MR8	2.2	±20%	190	0.080	930	0.1	
B C3225T3R3MR8	3.3	±20%	160	0.095	820	0.1	
B C3225T4R7MR8	4.7	±20%	70	0.100	680	0.1	
B C3225T6R8MR8	6.8	±20%	50	0.120	620	0.1	
.B C3225T100[]R8	10	±10%, ±20%	23	0.133	540	0.1	
.B C3225T150[R8	15	±10%, ±20%	20	0.195	420	0.1	
.B C3225T220[]R8	22	±10%, ±20%	17	0.27	330	0.1	
B C3225T330[]R8	33	±10%, ±20%	13	0.41	300	0.1	
B C3225T470[R8	47	±10%, ±20%	10	0.67	220	0.1	
B C3225T680[R8	68	±10%, ±20%	8	1.0	190	0.1	
B C3225T101 B8	100	$\pm 10\% \pm 20\%$	6	14	150	0.1	

Decision of the Inductance tolerance code (K or M)

·LB、LBCseries

*) Rated Current: The maximum DC value having inductance decrease within 10 % and temperature increase within 20 degC by the application of DC bias.

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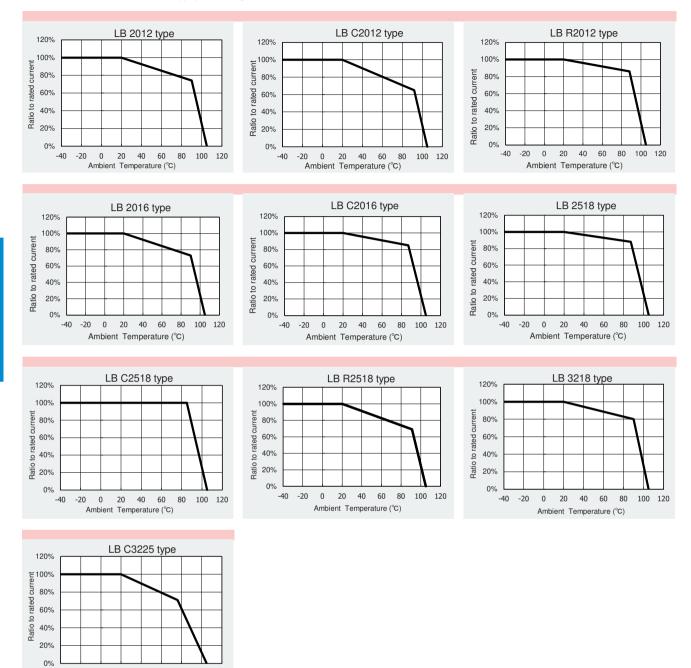
INDL

for High Quality Equipment

Derating of Rated Current

LB series

Derating of current is necessary for LB series depending on ambient temperature. Please refer to the chart shown below for appropriate derating of current.



This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our product specification sheets. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our website (http://www.ty-top.com/).

-40 -20 0 20 40 60 80

100 120

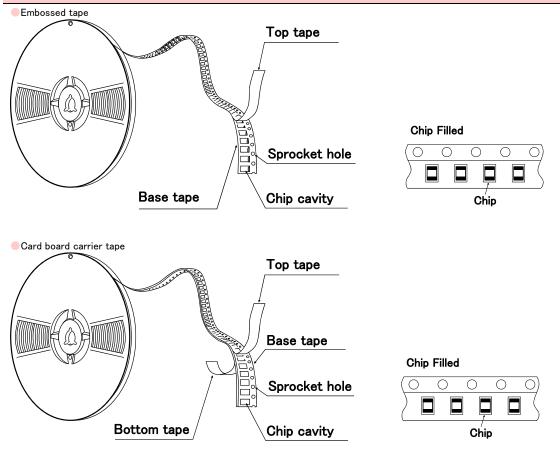
Ambient Temperature (°C)

WIRE-WOUND CHIP INDUCTORS (LB SERIES), WIRE-WOUND CHIP POWER INDUCTORS (CB SERIES), WIRE-WOUND CHIP INDUCTORS FOR SIGNAL LINES (LB SERIES M TYPE)

PACKAGING

1Minimum Quantity					
	Standard Quantity [pcs]				
Туре	Paper Tape	Embossed Tape			
LB C3225	_	1000			
CB C3225		1000			
LB 3218	—	2000			
LB R2518					
LB C2518					
LB 2518	-	2000			
CB 2518					
CB C2518					
LBM2016					
LB C2016					
LB 2016	—	2000			
CB 2016					
CB C2016					
LB 2012					
LB C2012					
LB R2012	—	3000			
CB 2012					
CB C2012					
CB L2012	4000	_			
LB 1608	4000	-			
LBMF1608	_	3000			
CBMF1608		0000			

2 Tape material



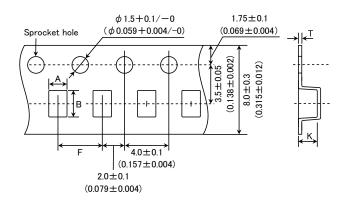
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i_wound_CB_LB_pack_e-E05R01



③Taping Dimensions

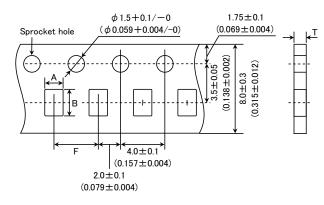
Embossed Tape (0.315 inches wide)



T	Chip	cavity	Insertion pitch	Insertion pitch Tape thickr		
Туре	А	В	F	Т	К	
LBM2016	1.75 ± 0.1 (0.069 ± 0.004)	2.1±0.1 (0.083±0.004)	4.0 ± 0.1 (0.157 ± 0.004)	0.3±0.05 (0.012±0.002)	1.9max. (0.075max.)	
LB C3225 CB C3225	2.8±0.1 (0.110±0.004)	3.5 ± 0.1 (0.138 ± 0.004)	4.0±0.1 (0.157±0.004)	0.3±0.05 (0.012±0.002)	4.0max. (0.157max.)	
LB 3218	2.1±0.1 (0.083±0.004)	3.5 ± 0.1 (0.138 ± 0.004)	4.0 ± 0.1 (0.157±0.004)	0.3±0.05 (0.012±0.002)	2.2max. (0.087max.)	
LB 2518 CB 2518 LB C2518 CB C2518 LB R2518	2.15±0.1 (0.085±0.004)	2.7±0.1 (0.106±0.004)	4.0±0.1 (0.157±0.004)	0.3±0.05 (0.012±0.002)	2.2max. (0.087max.)	
LB 2016 CB 2016 LB C2016 CB C2016	1.75±0.1 (0.069±0.004)	2.1±0.1 (0.083±0.004)	4.0±0.1 (0.157±0.004)	0.3±0.05 (0.012±0.002)	1.9max. (0.075max.)	
LB 2012 CB 2012 LB C2012 CB C2012 LB R2012	1.45±0.1 (0.057±0.004)	2.25±0.1 (0.089±0.004)	4.0±0.1 (0.157±0.004)	0.25±0.05 (0.010±0.002)	1.45max. (0.057max.)	
LBMF1608 CBMF1608	$ \begin{array}{r} 1.1 \pm 0.1 \\ (0.043 \pm 0.004) \end{array} $	1.9 ± 0.1 (0.075 ± 0.004)	4.0 ± 0.1 (0.157 ± 0.004)	0.25±0.05 (0.010±0.002)	1.2max. (0.047max.)	

Unit:mm(inch)

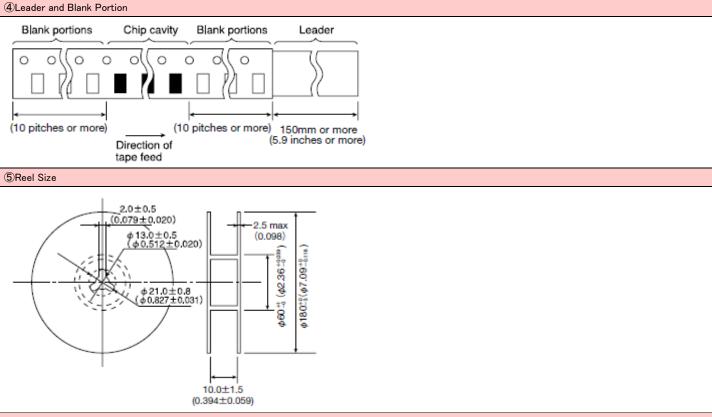
Card board carrier tape (0.315 inches wide)



Tune	Chip	cavity	Insertion pitch	Tape thickness
Туре	A	В	F	Т
CB L2012	1.55 ± 0.1	2.3±0.1	4.0±0.1	1.1max.
GB LZUIZ	(0.061 ± 0.004)	(0.091 ± 0.004)	(0.157 ± 0.004)	(0.043max.)
LB 1608	1.0 ± 0.1	1.8±0.1	4.0±0.1	1.1max.
LB 1608	(0.039 ± 0.004)	(0.071 ± 0.004)	(0.157 ± 0.004)	(0.043max.)
				l lucit : mama (im ala)

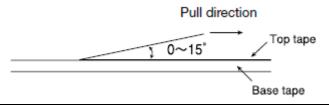
Unit:mm(inch)





6 Top Tape Strength

The top tape requires a peel-off force 0.2 to 0.7N in the direction of the arrow as illustrated below.



WIRE-WOUND CHIP INDUCTORS (LB SERIES), WIRE-WOUND CHIP POWER INDUCTORS (CB SERIES), WIRE-WOUND CHIP INDUCTORS FOR SIGNAL LINES (LB SERIES M TYPE)

RELIABILITY DATA

1.Operating temper	ature Range					
	LB, LBC, LBR Series					
Specified Value	CB, CBC Series	$-40 \sim +105^{\circ}$ C (Including self-generated heat)				
	LBM Series					
Test Methods and Remarks	Including self-generated heat					
2. Storage Tempera	ture Range(after soldering)					
	LB, LBC, LBR Series					
Specified Value	CB, CBC Series	-40~+85°C				
	LBM Series					
Test Methods and Remarks	LB, CB Series: Please refer the term of "7. storage conditions" in precaution	S.				
3.Rated Current						
	LB, LBC, LBR Series					
Specified Value	CB, CBC Series	Within the specified tolerance				
	LBM Series	1				
4.Inductance						
	LB, LBC, LBR Series					
Specified Value	CB, CBC Series Within the specified tolerance					
	LBM Series					
Test Methods and	LB·LBC·LBR·CB·CBC·LBM Series					
Remarks	Measuring equipment :LCR Mater (HP4285A or its e	quivalent)				
-						
5.Q						
	LB, LBC, LBR Series					
Specified Value	CB, CBC Series					
	LBM Series	Within the specified tolerance				
Test Methods and	LBM Series					
Remarks	Measuring equipment : LCR Mater(HP4285A or its eq	uivalent)				
6.DC Resistance						
	LB, LBC, LBR Series					
Specified Value	CB, CBC Series	Within the specified tolerance				
	LBM Series					
Test Methods and Remarks	Measuring equipment : DC Ohmmeter(HIOKI 3227 or its equ	ivalent)				

7.Self-Resonant Frequency						
Specified Value	LB, LBC, LBR Series					
	CB, CBC Series	Within the specified tolerance				
	LBM Series					
Test Methods and Remarks	Measuring equipment : Impedance analyzer (HP4291A or its equivalent)					



8.Temperature Char	racteristic				
	LBM2016				Inductance change : Within±10%
	LB2012	LBR2012	CB2012	LB2016	
	CB2016	LB2518	LBR2518	CB2518	Inductance change : Within±20%
Specified Value	LBC3225	CBC3225			
	LBC2016	CBC2016	LBC2518	CBC2518	
	LB3218				Inductance change : Within±25%
	LBC2012	CBC2012			Inductance change : Within±35%
	Change of	maximum inductar	nce deviation in	step 1-5	
	Step	Temperature (°C)			
	Step	LB, CB Serie			
Test Methods and	1		20		
Remarks	2		-40		
	3	20(Referen	nce temperature	e)	
	4	+85(Maximum o	operating tempe	rature)	
	5		20		

Specified Value CB,	, LBC, LBR Series , CBC Series M Series rp : 2mm (LB • LBC • LBR • CB • CBC • LBM Series) st substrate : Board according to JIS C0051	No damage.
LBM Warp Test	M Series rp : 2mm(LB•LBC•LBR•CB•CBC•LBM Series)	
Warp Test	rp : 2mm(LB·LBC·LBR·CB·CBC·LBM Series)	
Test	•	
Test Methods and Remarks	ckness : 1.0mm Pressing jig 10 10 R340 R340 Board	

10.Body Strength			
	LB, LBC, LBR Series		
Specified Value	CB, CBC Series	No damage.	
	LBM Series		
Test Methods and Remarks	LB+LBC+LBR+CB+CBC+LBM Applied force : 10N Duration : 10sec.		

11.Adhesion of terminal electrode						
	LB, LBC, LBR Series					
Specified Value	CB, CBC Series		No abnormality.			
	LBM Series					
Test Methods and Remarks	LB•LBC•LBR•CB Applied force Duration Test substrate	•CBC•CBL•LBM : 10N to X and Y directions 5 sec. : Printed board				

12.Resistance to vibration							
Specified Value	LB, LBC, LBR Series		Inductance change : Within±20% No significant abnormality in appearance.				
	CB, CBC Series						
	LBM Series		Inductance change : Within $\pm 20\%$ No significant abnormality in appearance.				
Test Methods and Remarks	LB+LBR+LBC+CB+CB Vibration type Directions Frequency range Amplitude Mounting method Recovery	 3C•LBM : According to JIS C5102 clauses: A 2 hrs each in X, Y and Z directions 10 to 55 to 10 Hz(1min.) 1.5mm Soldering onto printed board At least 2 hrs of recovery under the hrs. 					

13.Drop test						
	LB, LBC, LBR Series					
Specified Value	CB, CBC Series	—				
	LBM Series]				

14.Solderability			
Specified Value	LB, LBC, LBR Series		
	CB, CBC Series		At least 90% of surface of terminal electrode is covered by new
	LBM Series		
Test Methods and Remarks	LB·LBC·LBR·CB·CBC·CBL·LBM: Solder temperature : 245±5°C Duration : 5±0.5sec Flux : Methanol solution with 25% of colophony		

15.Resistance to so	15.Resistance to soldering			
	LB, LBC, LBR Series			
Specified Value	CB, CBC Series	Inductance change : Within±20%		
	LBM Series	Inductance change : Within±20%		
Test Methods and Remarks	LB·LBC·LBR·CB·CBC·CBL·LBM: 3 times of reflow oven at 230°C MIN for 40sec. with peak temperature at 260 °C for 5sec.			

16.Resisitance to so	16.Resisitance to solvent			
Specified Value	LB, LBC, LBR Series			
	CB, CBC Series] –	
	LBM Series			
Test Methods and Remarks	Solvent temperature Type of solvent Cleaning conditions	: Room temperature : Isopropyl alcohol : 90s. Immersion and cleaning.		

17.Thermal shock		
Specified Value	LB, LBC, LBR Series	Inductance change : Within±20% No significant abnormality in appearance.
	CB, CBC Series	
	LBM Series	
Test Methods and Remarks	LB·LBC·LBR·CB·CBC·CBL·LBM: -40~+85°C, maintain times 30min. ,100 cycle Recovery : At least 2 hrs of recovery under the standard condition after the test, followed by the measurement within 48 hrs	

18.Damp heat life test				
Specified Value	LB, LBC, LBR Series			
	CB, CBC Series		Inductance change : Within±20% No significant abnormality in appearance.	
	LBM Series			
	Temperature	: 60±2°C		
Test Methods and	Humidity	: 90~95%RH		
Remarks	Duration	: 1000 hrs		
	Recovery	: At least 2 hrs of recovery under th	e standard condition after the test, followed by the measurement within 48 hrs.	

19.Loading under damp heat life test				
	LB, LBC, LBR Series		Inductance change : Within±20% No significant abnormality in appearance.	
Specified Value	CB, CBC Series			
	LBM Series			
Test Methods and Remarks	Temperature Humidity Duration Applied current Recovery	: 60±2°C : 90~95%RH : 1000 hrs : Rated current : At least 2 hrs of recovery under the st	andard condition after the test, followed by the measurement within 48 hrs.	

20.High temperature life test			
	LB, LBC, LBR Series		-
Specified Value	CB, CBC Series		Inductance change : Within±20% No significant abnormality in appearance.
	LBM Series		
Test Methods and Remarks	Temperature Duration Recovery	: 85±2°C : 1000 hrs : At least 2 hrs of recovery under the standard condition after the test, followed by the measurement within 48 hrs.	

21.Loading at high temperature life test			
	I B I BC I BR Series		Inductance change : Within±20% No significant abnormality in appearance.
Specified Value	CB, CBC Series		
	LBM Series		
	Temperature	: 85±2°C	
Test Methods and	Duration	: 1000 hrs	
Remarks	Applied current	: Rated current	
Recovery : At least 2 hrs of recovery under the standard condition after the test, followed by the n		andard condition after the test, followed by the measurement within 48 hrs.	

22.Low temperature	22.Low temperature life test			
Specified Value	LB, LBC, LBR Series		Inductance change : Within±20% No significant abnormality in appearance.	
	CB, CBC Series			
	LBM Series			
Test Methods and Remarks	Temperature Duration Recovery	: -40±2°C : 1000 hrs : At least 2 hrs of recovery under the standard condition after the test, followed by the measurement within 48 hrs.		

23.Standard condition			
	LB, LBC, LBR Series	Standard test conditions	
	CB, CBC Series	Unless specified, Ambient temperature is $20\pm15^{\circ}$ C and the Re	
Specified Value	LBM Series	humidity is 65±20%. If there is any doubt about the test results, further measurement shall be had within the following limits: Ambient Temperature: 20±2°C Relative humidity: 65±5% Inductance value is based on our standard measurement systems.	

WIRE-WOUND CHIP INDUCTORS (LB SERIES), WIRE-WOUND CHIP POWER INDUCTORS (CB SERIES), WIRE-WOUND CHIP INDUCTORS FOR SIGNAL LINES (LB SERIES M TYPE)

PRECAUTIONS

1. Circuit Design	1
Precautions	 Operating environment The products listed in this catalogue are intended for use in general electronic equipment (e.g., AV equipment, OA equipment, home electric appliances, office equipment, information and communication equipment), general medical equipment, industrial equipment, and automotive interior applications, etc. Please be sure to contact TAIYO YUDEN for further information before using the products for any equipment which may directly cause loss of human life or bodily injury (e.g., specially controlled medical equipment, transportation equipment including, without limitation, automotive powertrain control system, train control system, and ship control system, traffic signal equipment). Please do not incorporate our products into any equipment requiring high levels of safety and/or reliability (e.g., aerospace equipment, aviation equipment, nuclear control equipment, undersea equipment, military equipment, etc.).

2. PCB Design	
Precautions	 ◆Land pattern design 1. Please contact any of our offices for a land pattern, and refer to a recommended land pattern of a right figure or specifications.
Technical considerations	PRECAUTIONS [Recommended Land Patterns] Surface Mounting • Mounting and soldering conditions should be checked beforehand. • Applicable soldering process to those products is reflow soldering only.

3. Considerations for automatic placement		
Precautions	 Adjustment of mounting machine 1. Excessive impact load should not be imposed on the products when mounting onto the PC boards. 2. Mounting and soldering conditions should be checked beforehand. 	
Technical considerations	1. When installing products, care should be taken not to apply distortion stress as it may deform the products.	

4. Soldering	
Precautions	 Reflow soldering(LB and CB Types) 1. For reflow soldering with either leaded or lead-free solder, the profile specified in "point for controlling" is recommended. Recommended conditions for using a soldering iron 1. Put the soldering iron on the land-pattern. Soldering iron's temperature - Below 350°C Duration-3 seconds or less. The soldering iron should not come in contact with inductor directly.
Technical considerations	 Reflow soldering(LB and CB Types) Reflow profile Reflow profile Reflow profile Sec max Peak: 200 90±30sec 30±10sec 30±10sec Heating Time [sec] Recommended conditions for using a soldering iron Components can be damaged by excessive heat where soldering conditions exceed the specified range.

5. Cleaning	
Precautions	♦ Cleaning conditions Washing by supersonic waves shall be avoided.
Technical considerations	 ♦ Cleaning conditions If washed by supersonic waves, the products might be broken.

6. Handling	
Precautions	 Handling Keep the inductors away from all magnets and magnetic objects. Breakaway PC boards (splitting along perforations) When splitting the PC board after mounting inductors, care should be taken not to give any stresses of deflection or twisting to the board. Board separation should not be done manually, but by using the appropriate devices. Mechanical considerations Please do not give the inductors any excessive mechanical shocks.
Technical considerations	 Handling 1. There is a case that a characteristic varies with magnetic influence. Breakaway PC boards (splitting along perforations) 1. Planning pattern configurations and the position of products should be carefully performed to minimize stress. Mechanical considerations 1. There is a case to be damaged by a mechanical shock.

7. Storage conditions		
Precautions	 Storage To maintain the solderability of terminal electrodes and to keep the packing material in good condition, temperature and humidity in the storage area should be controlled. Recommended conditions	
Technical considerations	 Storage Under a high temperature and humidity environment, problems such as reduced solderability caused by oxidation of terminal electrodes and deterioration of taping/packaging materials may take place. 	

Mouser Electronics

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Taiyo Yuden:

<u>LBM2016T1R8J</u> <u>LBM2016T6R8J</u> <u>LBM2016TR82J</u> <u>LB2518T102K8</u> <u>LB2518T221K8</u> <u>LBR2012T100M8</u> LBR2012T4R7M8